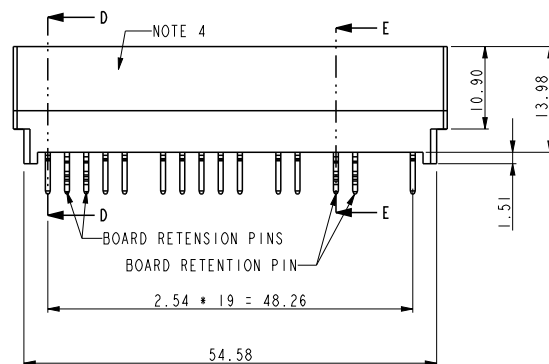
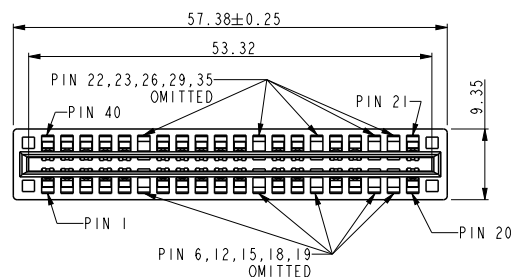
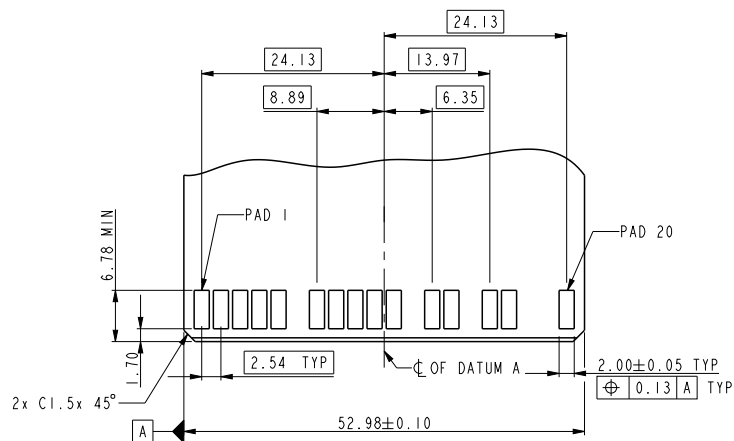


NOTE:

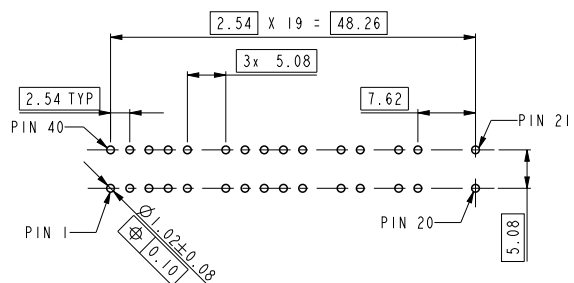
- NOTE:
1. MATERIAL:
HOUSING: HIGH TEMPERATURE THERMOPLASTIC,
UL 94 V-O FLAME RETARDANT.
TERMINAL: HIGH CONDUCTIVITY COPPER ALLOY.
PLATING SPEC AS BELOW:
Ni 50u" UNDER PLATED.
Au 30u" OVER CONTACT AREA.(ONE SIDE)
MATTE PURE TIN 120u" OVER SOLDERING AREA.
2. PACKING SPEC. GS-14-937
3. PRODUCT SPEC. GS-12-338.
④ MANUFACTURER'S NAME, P/N AND DATE CODE
TO APPEAR ON THIS SURFACE AS PER GS-24-007.

5. PART NUMBER 10046971-044LF MEETS EUROPEAN UNION DIRECTIVE AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A CIRCUIT BOARD.
6. THE PINS 6, 12, 15, 18, 19, 22, 23, 26, 29, 35 ARE OMITTED.

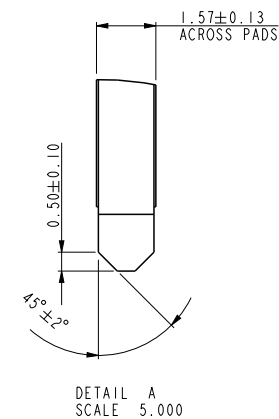
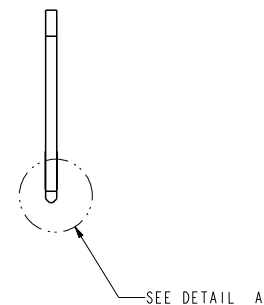
spec ref *				dr Julia Wang 2013/12/18		projection 		MM		size A4		scale 1.000									
tolerance std ISO 406 ISO 1101 TOLERANCES UNLESS OTHERWISE SPECIFIED				eng Julia Wang 2014/03/20						ecn no -											
				chr -						rel level Released											
				appr Pei-Ming Zheng 2014/03/20		product family		Power Edge Card													
surface  ISO 1302		linear		0.X		±0.50				title		VERTICAL TYPE 2X20P(10P OMITTED)		dwg no		10046971-044		rev		A	
				0.XX		±0.25															
				0.XXX		±0.13															
angular		0°		±2°		www.fci.com		cat. no.		*		Product - Customer Drw				sheet 1 of 2					



RECOMMENDED MATING BOARD



RECOMMENDED PC BOARD LAYOUT
AND THE THICKNESS IS 3.18mm



dr	Julia Wang	2013/12/18	projection	MM	size	A4	scale	1.000
eng	Julia Wang	2014/03/20			ecn no	-		
chr	-	-			rel level	Released		
appr	Pei-Ming Zheng	2014/03/20	product family	Power Edge Card				
		title			dwg no		rev	
		VERTICAL TYPE 2X20P(10P OMITTED)			10046971-044		A	
www.fci.com		cat. no.		*	Product - Customer Drw		sheet 2 of 2	